

EP 10 Core and accessories

Series/Type: B65841, B65842

Date: October 2022

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EP 10

Core B65841

- To IEC 63093-5
- For transformers featuring high inductance and low overall height
- For power applications
- Delivery mode: sets

Magnetic characteristics (per set)

 $\Sigma I/A = 1.7 \text{ mm}^{-1}$

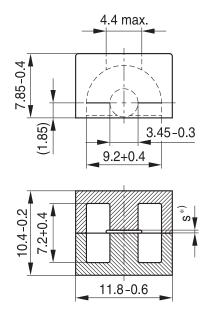
 $I_{e} = 19.2 \text{ mm}$

 $A_{\rm e} = 11.3 \, \rm mm^2$

 $A_{min} = 8.5 \text{ mm}^2$

 $V_e = 217 \text{ mm}^3$

Approx. weight 2.8 g/set



*) gapped (one-sided)

FEP0112-C-E

Gapped (A_L values/air gaps examples)

Material	A _L value	s	μ_{e}	Ordering code
		approx.		
	nH	mm		
T38	63 ±3%	0.22	85	B65841A0063A038
	100 ±3%	0.14	135	B65841A0100A038
	160 ±5%	0.09	216	B65841A0160J038
	200 ±6%	0.07	270	B65841A0200C038
	250 ±7%	0.05	338	B65841A0250E038
T57	63 ±3%	0.22	85	B65841A0063A057
	100 ±3%	0.14	135	B65841A0100A057
	160 ±5%	0.09	216	B65841A0160J057
	200 ±6%	0.07	270	B65841A0200C057
	250 ±7%	0.05	338	B65841A0250E057
N45	63 ±3%	0.22	85	B65841A0063A045
	100 ±3%	0.14	135	B65841A0100A045
	160 ±5%	0.08	216	B65841A0160J045
	200 ±6%	0.07	270	B65841A0200C045
	250 ±7%	0.05	338	B65841A0250E045
N87	63 ±3%	0.22	85	B65841A0063A087
	100 ±3%	0.13	135	B65841A0100A087
	160 ±5%	0.08	216	B65841A0160J087
	200 ±6%	0.06	270	B65841A0200C087
	250 ±7%	0.05	338	B65841A0250E087



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Ungapped

Material	A _L value nH	μ _e	P _V W/set	Ordering code
N45	1600 +30/–20%	2160		B65841A0000R045
N30	2000 +30/–20%	2700		B65841A0000R030
T57	1600 +30/–20%	2160		B65841A0000R057
T65	2900 +30/–20%	3920		B65841A0000R065
T38	4800 +40/–30%	6490		B65841A0000Y038
N87	1100 +30/–20%	1480	< 0.1 (200 mT, 100 kHz, 100 °C)	B65841A0000R087

Other A_L values/air gaps and materials available on request – see Processing remarks on page 6.



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Coil former, squared pins

Material: GFR thermosetting plastic (UL 94 V-0, insulation class to IEC 60085:

F

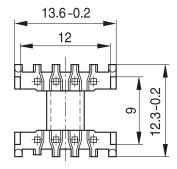
max. operating temperature 155 °C), color code black

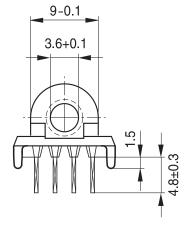
Sumikon PM 9630® [E41429 (M)], SUMITOMO BAKELITE CO LTD

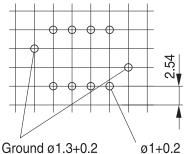
Solderability: to IEC 60068-2-20, test Ta, method 1 (aging 3): 235 °C, 2 s Resistance to soldering heat: to IEC 68-2-20, test Tb, method 1B: 350 °C, 3.5 s

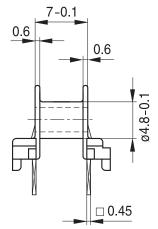
Winding: see Processing notes, 2.1

Sections	A _N mm ²	I _N mm	A_R value $\mu\Omega$	Terminals	Ordering code
1	12.1	21.5	61.3	8	B65842W1008D001
2	11.6	21.5	63.7	8	B65842W1008D002

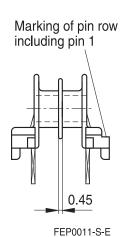








Hole arrangement View in mounting direction





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Mounting assembly

The set comprises a yoke and a clamp

Yoke

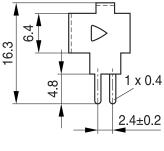
Made of cold rolled steel (0.4 mm) with ground terminal (tinned)

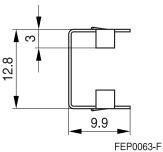
Clamp

Spring clamp, made of bronze (0.3 mm), tinned

	Ordering code
Complete mounting assembly	B65842S2000X000

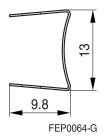
Yoke





Clamps





Dimensional tolerances +/-0,2

Dimensions in mm



Cautions and warnings

Mechanical stress and mounting

Ferrite cores have to meet mechanical requirements during assembling and for a growing number of applications. Since ferrites are ceramic materials one has to be aware of the special behavior under mechanical load.

As valid for any ceramic material, ferrite cores are brittle and sensitive to any shock, fast temperature changing or tensile load. Especially high cooling rates under ultrasonic cleaning and high static or cyclic loads can cause cracks or failure of the ferrite cores.

For detailed information see data book, chapter "General - Definitions, 8.1".

Effects of core combination on A₁ value

Stresses in the core affect not only the mechanical but also the magnetic properties. It is apparent that the initial permeability is dependent on the stress state of the core. The higher the stresses are in the core, the lower is the value for the initial permeability. Thus the embedding medium should have the greatest possible elasticity.

For detailed information see data book, chapter "General - Definitions, 8.1".

Heating up

Ferrites can run hot during operation at higher flux densities and higher frequencies.

NiZn-materials

The magnetic properties of NiZn-materials can change irreversible in high magnetic fields.

Ferrite Accessories

Our ferrite accessories have been designed and evaluated only in combination with our ferrite cores. We explicitly point out that our ferrite accessories or our ferrite cores may not be compatible with those of other manufacturers. Any such combination requires prior testing by the customer and will be at the customer's own risk.

We assume no warranty or reliability for the combination of our ferrite accessories with cores and other accessories from any other manufacturer.

Processing remarks

The start of the winding process should be soft. Else the flanges may be destroyed.

- Too strong winding forces may blast the flanges or squeeze the tube that the cores can not be mounted any more.
- Too long soldering time at high temperature (>300 °C) may effect coplanarity or pin arrangement.
- Not following the processing notes for soldering of the J-leg terminals may cause solderability problems at the transformer because of pollution with Sn oxyde of the tin bath or burned insulation of the wire. For detailed information see chapter "Processing notes", section 2.2.
- The dimensions of the hole arrangement have fixed values and should be understood as a recommendation for drilling the printed circuit board. For dimensioning the pins, the group of holes can only be seen under certain conditions, as they fit into the given hole arrangement. To avoid problems when mounting the transformer, the manufacturing tolerances for positioning the customers' drilling process must be considered by increasing the hole diameter.

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Cautions and warnings

Display of ordering codes for TDK Electronics products

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Symbols and terms

Symbol	Meaning	Unit
A	Cross section of coil	mm ²
A_{e}	Effective magnetic cross section	mm ²
A_L	Inductance factor; $A_L = L/N^2$	nH
A_{L1}	Minimum inductance at defined high saturation ($\triangleq \mu_a$)	nH
A _{min}	Minimum core cross section	mm ²
A _N	Winding cross section	mm ²
A_R	Resistance factor; $A_R = R_{Cu}/N^2$	$\mu\Omega = 10^{-6} \Omega$
В	RMS value of magnetic flux density	Vs/m ² , mT
ΔΒ	Flux density deviation	Vs/m ² , mT
Ê	Peak value of magnetic flux density	Vs/m ² , mT
ΔÂ	Peak value of flux density deviation	Vs/m ² , mT
B_{DC}	DC magnetic flux density	Vs/m ² , mT
B _R	Remanent flux density	Vs/m ² , mT
B _S	Saturation magnetization	Vs/m ² , mT
C_0	Winding capacitance	F = As/V
CDF	Core distortion factor	mm ^{-4.5}
DF	Relative disaccommodation coefficient DF = d/μ_i	
d	Disaccommodation coefficient	
E_a	Activation energy	J
f	Frequency	s−1, Hz
f _{cutoff}	Cut-off frequency	s−1, Hz
f _{max}	Upper frequency limit	s−1, Hz
f _{min}	Lower frequency limit	s−1, Hz
f _r	Resonance frequency	s−1, Hz
f _{Cu}	Copper filling factor	
g	Air gap	mm
H	RMS value of magnetic field strength	A/m
Ĥ	Peak value of magnetic field strength	A/m
H_{DC}	DC field strength	A/m
H _c	Coercive field strength	A/m
h	Hysteresis coefficient of material	10 ⁻⁶ cm/A
h/μ_i^2	Relative hysteresis coefficient	10 ⁻⁶ cm/A
1	RMS value of current	Α
I_{DC}	Direct current	Α
Î	Peak value of current	A
J	Polarization	Vs/m ²
k	Boltzmann constant	J/K
k ₃	Third harmonic distortion	
k _{3c}	Circuit third harmonic distortion	
I	Inductance	H = Vs/A



Symbols and terms

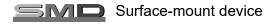
Symbol	Meaning	Unit
Δ L/L	Relative inductance change	Н
L_0	Inductance of coil without core	Н
L _H	Main inductance	Н
L_p	Parallel inductance	Н
L _{rev}	Reversible inductance	Н
L _s	Series inductance	Н
l _e	Effective magnetic path length	mm
I _N	Average length of turn	mm
N	Number of turns	
P_{Cu}	Copper (winding) losses	W
P _{trans}	Transferrable power	W
P _V	Relative core losses	mW/g
PF	Performance factor	
Q	Quality factor (Q = $\omega L/R_s$ = 1/tan δ_l)	
R	Resistance	Ω
R_{Cu}	Copper (winding) resistance (f = 0)	Ω
R _h	Hysteresis loss resistance of a core	Ω
ΔR_h	R _h change	Ω
R _i	Internal resistance	Ω
R_p	Parallel loss resistance of a core	Ω
R_s	Series loss resistance of a core	Ω
R _{th}	Thermal resistance	K/W
R _V	Effective loss resistance of a core	Ω
S	Total air gap	mm
Т	Temperature	°C
ΔT	Temperature difference	K
T_{C}	Curie temperature	°C
t	Time	s
t_v	Pulse duty factor	
tan δ	Loss factor	
tan δ_{l}	Loss factor of coil	
$tan \delta_r$	(Residual) loss factor at $H \rightarrow 0$	
$tan \delta_e$	Relative loss factor	
$tan \delta_h$	Hysteresis loss factor	
tan δ/μ_i	Relative loss factor of material at H \rightarrow 0	
U	RMS value of voltage	V
Û	Peak value of voltage	V
V _e	Effective magnetic volume	mm ³
Z	Complex impedance	Ω
Z _n	Normalized impedance $ Z _n = Z / N^2 \times \varepsilon (I_e / A_e)$	Ω/mm



Symbols and terms

Symbol	Meaning	Unit	
α	Temperature coefficient (TK)		
α_{F}	Relative temperature coefficient of material	1/K	
α_{e}	Temperature coefficient of effective permeability	1/K	
r	Relative permittivity		
Þ	Magnetic flux	Vs	
1	Efficiency of a transformer		
Ів	Hysteresis material constant	mT-1	
li	Hysteresis core constant	$A^{-1}H^{-1/2}$	
'S	Magnetostriction at saturation magnetization		
,	Relative complex permeability		
0	Magnetic field constant	Vs/Am	
а	Relative amplitude permeability		
арр	Relative apparent permeability		
е	Relative effective permeability		
i	Relative initial permeability		
p '	Relative real (inductive) component of $\overline{\mu}$ (for parallel components)		
p"	Relative imaginary (loss) component of $\overline{\mu}$ (for parallel components)		
r	Relative permeability		
rev	Relative reversible permeability		
s'	Relative real (inductive) component of $\overline{\mu}$ (for series components)		
s"	Relative imaginary (loss) component of $\overline{\mu}$ (for series components)		
tot	Relative total permeability		
	derived from the static magnetization curve		
	Resistivity	Ω m $^{-1}$	
I/A	Magnetic form factor	mm ⁻¹	
Cu	DC time constant $\tau_{Cu} = L/R_{Cu} = A_L/A_R$	s	
)	Angular frequency; ω = 2 Π f	s ⁻¹	

All dimensions are given in mm.





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